

# **Applications Note:SY58863**

Single Stage Boost PFC LED Driver Dimmable, High PF and Low BOM Cost

## **General Description**

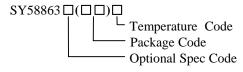
SY58863 is a single-stage Boost PFC driver for LED lighting applications. Good compatibility is achieved with Leading/Trailing edge dimmer and high PF is achieved without any dimmer.

SY58863 drives the converter in Quasi-Resonant mode to achieve high efficiency. Reliable Open LED protections are integrated.

SY58863 integrates high voltage power FET inside to save driver space further.

SY58863 is available in SO8 package.

## **Ordering Information**



Ordering Number	Package type	Note
SY58863FAC	SO8	

### **Features**

- Compatible with Leading Edge/Trailing Edge Dimmer
- High PF without Any Dimmer
- 500V MOSFET Integrated
- Quasi-Resonant Operation
- Reliable Open LED Protection
- Thermal Fold Back
- Low BOM Cost
- Compact Package: SO8

## **Applications**

- LED Lighting
- Leading Edge Dimming
- Trailing Edge Dimming

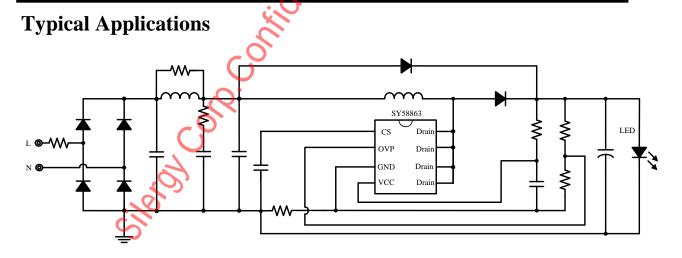
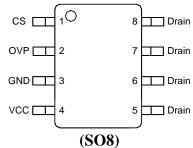


Figure 1. Typical application



## Pinout (top view)



**Top Mark: BVB**xyz (device code: BVB, x=year code, y=week code, z= lot number code)

Pin Name	PIN Number	Pin Description
CS	1	Current sense pin, connect a cap and sense res to GND pin. $R_{CS} = \frac{V_{REF}}{2I_{O}}$
OVP	2	Voltage sense pin. Connect to a resistor divider of inductor or auxiliary winding to sense output voltage. $V_{\text{OVP}} \! = \! K \times V_{\text{OVP,REF}} , \text{ where } K \text{ is the OVP resistor ratio coefficient.}$
GND	3	Ground pin.
VCC	4	Bias supply pin.
Drain	5-8	Internal MOSFET drain node.

# **Block Diagram**

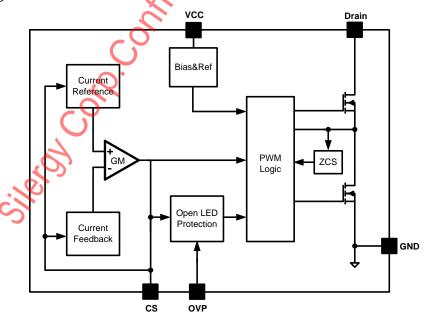


Fig.2 Simplified block diagram



Absolute Maximum Ratings (Note 1)	
VCC	
I <sub>VCC</sub>	4mA
CS, OVP	
Drain	500V
Power Dissipation, @ T <sub>A</sub> = 25°C SO8	1.1W
Package Thermal Resistance (Note 2)	
SO8, $\theta_{JA}$	88°C/W
SO8, $\theta_{JC}$	45°C/W
Maximum Junction Temperature	165°C
Lead Temperature (Soldering, 10 sec.)	260°C
Storage Temperature Range	

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### **Electrical Characteristics**

 $(V_{VCC} = 12V, T_A = 25^{\circ}C \text{ unless otherwise specified})$ 

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Power Supply Section	Power Supply Section					
VCC Turn-on Threshold	V <sub>VCC_ON</sub>		13.2	14.1	15.0	V
VCC Turn-off Threshold	V <sub>VCC_OFF</sub>		6.8	7.4	8.0	V
VCC Shunt Voltage	V <sub>VCC_Shunt</sub>		13.5	14.5	15.5	V
Start up Current	$I_{ST}$		35	45	55	μA
Quiescent Current	$I_Q$		170	217	260	μA
CS Pin Section						
Current Reference	$V_{REF}$		210	218	226	mV
CS Limit	V <sub>CS_MAX</sub>		1.6	1.7	1.8	V
OVP Pin Section			X			
OVP Voltage Reference	V <sub>OVP_REF</sub>		1.14	1.22	1.3	V
<b>Driver Section</b>	Driver Section Control of the Contro					
Min ON Time	T <sub>ON_MIN</sub>		,	500		ns
Max ON Time	$T_{ON\_MAX}$	<b>LO</b>		10.5		μs
Min OFF Time	T <sub>OFF_MIN</sub>	E		1.5		μs
Max OFF Time	T <sub>OFF_MAX</sub>			250		μs
Integrated MOSFET Section						
BV of HV MOSFET	$V_{\mathrm{BV}}$		500			V
HV MOS Drain Source Resistance	R <sub>DSON_H</sub>			4.5	6	Ω
Thermal Section						
Thermal Fold Back Temperature	$T_{FB}$			160		°C
Thermal Shut Down Temperature	T <sub>SD</sub>			T <sub>FB</sub> +5		°C

**Note 1**: Stresses beyond the "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 2:  $\theta$  JA is measured in the natural convection at TA = 25°C on a low effective single layer thermal conductivity test board of JEDEC 51-3 thermal measurement standard. Test condition: Device mounted on 2" x 2" FR-4 substrate PCB, 2oz copper, with minimum recommended pad on top layer and thermal vias to bottom layer ground plane



### **Operation**

SY58863 is a single stage Boost PFC regulator targeting at LED lighting applications.

It is mainly used in mains dimming application and has good compatibility with Leading/Trailing edge dimmer.

In order to reduce the switching losses and improve EMI performance, Quasi-Resonant switching mode is applied, which means to turn on the power MOSFET at the valley of drain voltage.

It also provides reliable open LED protections and over temperature protection.

The IC is available with SO8 package.

### **Applications Information**

### Start up

After AC supply is powered on, the capacitor  $C_{VCC}$  between VCC and GND pin is charged up by output voltage (peak value of input voltage at the first of power on). Once  $V_{VCC}$  rises up to  $V_{VCC\_ON}$ , the internal blocks start to work and  $V_{CS}$  is pre-charged to certain value.

The whole start up procedure is divided into three sections as shown below.  $t_{ST1}$  is the  $C_{VCC}$  charged up time.  $t_{ST2}$  is the time  $V_{CS}$  is charged up to certain value.  $t_{ST3}$  is the time IC works at steady state. Usually  $t_{ST2}$  is much smaller than  $t_{ST1}$ .

If bias supply has more power than IC consumption,  $V_{VCC}$  is greater than  $V_{VCC\_Shunt}$ , and then a shunt current starts to work.

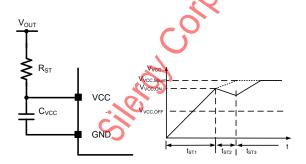


Fig.3 Start up

The start up component  $R_{ST}$  and  $C_{VCC}$  are designed as below:

(a) Set start-up resistor  $R_{ST}$ , make sure that the operation current is enough through  $R_{ST}$ . The worst case occurs at minimum input voltage, because after start up, the bias supply current is from  $V_{OUT}$  which is higher than peak value of input voltage.

$$R_{ST} < \frac{\sqrt{2}V_{AC,MIN}}{I_Q}$$

Where V<sub>AC\_MIN</sub> is the RMS value of minimum AC input voltage, I<sub>Q</sub> is the operation current.

(b) Select  $C_{VCC}$  to obtain an ideal start up time  $t_{ST}$ , and to make sure that the  $V_{VCC}{>}V_{VCC\_OFF}$  in  $t_{ST2}$ . The recommended formula is as below:

$$O_{\text{VCC}} = \frac{(\frac{\sqrt{2}V_{\text{AC,MIN}}}{R_{\text{ST}}} - I_{\text{ST}}) \times t_{\text{ST}}}{V_{\text{VCC,ON}}}$$

Where  $I_{ST}$  is the start up current.  $V_{VCC\_ON}$  is the start up voltage of internal circuit.

#### Shut down

After AC supply is powered off, the energy stored in the output capacitor is discharged. When power supply for IC is not enough,  $V_{VCC}$  drops down. Once  $V_{VCC}$  is below  $V_{VCC\_OFF}$ , the IC stops working.

#### LED current setting

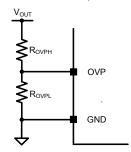
LED current is set by the resistor  $R_{CS}$ . The formula to program  $I_{LED}$  is as below:

$$I_{LED} = \frac{V_{REF}}{2 \times R_{CS}}$$

Where  $V_{REF}$  is the reference voltage.

#### **Open LED protection**

The protection voltage  $V_{\text{OVP}}$  for open LED is set by the resistor divider shown as below,



Then  $V_{OVP}$  is set by the formula,



$$V_{\text{OVP}} = \frac{R_{\text{OVPH}} + R_{\text{OVPL}}}{R_{\text{OVPL}}} V_{\text{OVP,REF}}$$

Where  $V_{OVP\_REF}$  is 1.2V. When OVP triggers, Switching stops and VCC is pulled down until  $V_{VCC\_OFF}$ , then IC starts up again and works in hiccup mode.

### **Thermal protection**

Thermal fold back is adopted in this IC. Thermal fold back curve is shown as below.

When the junction temperature rises too high, internal current reference decreases first; if the junction temperature still rises up over  $T_{SD}$ , IC will be shut down.

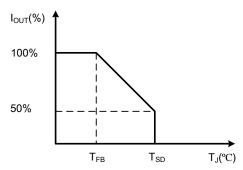


Fig.4 Thermal fold back curve

## **Power Device Design**

### **MOSFET and Diode**

When the operation condition is with maximum output voltage, the voltage stress of MOSFET and output power diode is maximized. MOSFET is integrated with 500V BV.

$$V_{DS\_MAX} = V_{OUT,MAX}$$

#### Inductor (L)

The system operates in the peak current mode. The ON time increases with the input voltage decreasing. When the ON time reaches  $T_{\text{ON\_MAX}}$ , the ON time is limit by  $T_{\text{ON\_MAX}}$ .

The input voltage and inductor current waveforms are shown as below, where  $\theta_1$  and  $\theta_2$  are the first time and last time that inductor current touches the limit in each half line cycle.  $V_{IN1}$  is the instantaneous value of input voltage at  $\theta_1$  and  $\theta_2$ .

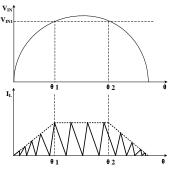


Fig.5 Input and output waveforms

In Quasi-Resonant mode, each switching period  $t_S$  consists of three parts: inductor current rising time  $t_1$ , falling time  $t_2$  and quasi-resonant time  $t_3$ .

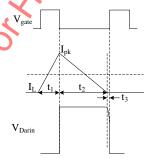


Fig.6 switching waveforms

The switching frequency is designed in rated input voltage considering conducted EMI test. Once the switching frequency  $f_{SW}$  is set, the inductance of the inductor could be calculated.

The design flow is shown as below:

- (a) Preset frequency  $f_{SW}$  at peak value of rated input voltage
- **(b)** Compute relative t<sub>S</sub>, t<sub>1</sub>

$$t_{\rm S} = \frac{1}{f_{\rm SW}}$$

$$t_1 = \frac{t_S \times (V_{OUT} - \sqrt{2}V_{AC\_RMS})}{V_{OUT}}$$

$$\mathbf{t}_2 = \mathbf{t}_S - \mathbf{t}_1$$

Where V<sub>AC\_RMS</sub> is the RMS value of rated input voltage.

(c) Compute the peak current of inductor I<sub>PK</sub>.



$$\begin{split} V_{\mathrm{IN1}} &= \sqrt{2} V_{\mathrm{AC\_RMS}} \, \frac{t_1}{t_{\mathrm{ON,MAX}}} \\ \theta_1 &= \arcsin(\frac{V_{\mathrm{IN1}}}{\sqrt{2} V_{\mathrm{AC\_RMS}}}) \\ I_{\mathrm{PK}} &\approx \frac{I_{\mathrm{OUT}} \cdot V_{\mathrm{OUT}} \cdot \pi}{\sqrt{2} V_{\mathrm{AC\_RMS}} \cdot \cos(\theta 1) \cdot \lambda} \end{split}$$

Where  $V_{OUT}$  is the rated output voltage,  $I_{OUT}$  is rated output current.  $t_{ON\_MAX}$  is maximum conducting time.  $\lambda$  is a coefficient that indicate the effect of negative resonant current and boost converter efficiency, and typically value is  $0.8 \sim 0.9$ .

(d) Design inductance L

$$L = \frac{\sqrt{2}V_{AC\_RMS} \times t_1}{I_{PK}}$$

#### Inductor design (N)

Necessary parameters:		
Inductance	L	
Io program resistor	R <sub>CS</sub>	
Current low limit voltage	$V_{CS,MIN}$	

V<sub>CS\_MIN</sub> is 500mV, The design rules are as followed:

- (a) Select the magnetic core type, identify the effective area  $A_e$ .
- (b) Preset the maximum magnetic flux  $\Delta B$ . For PC40,  $\Delta B$  selected to be 0.3~0.33T.
- (c) Compute inductor maximum peak current  $I_{L\_PK\_MAX}$  and maximum RMS current  $I_{L\_RMS\_MAX}$ .

$$I_{L\_PK\_MAX} = \frac{V_{CS\_MAX} - V_{CS\_MIN}}{R_{CS}}$$
$$I_{L\_RMS\_MAX} = \frac{1}{\sqrt{3}} I_{L\_PK\_MAX}$$

(d) Compute turn N

$$N = \frac{L}{\Delta B \times A_e} \times I_{L\_PK\_MAX}$$

- (e) Select an appropriate wire diameter with I<sub>L\_RMS\_MAX</sub>, select appropriate wire to make sure the current density ranges from 4A/mm<sup>2</sup> to 10A/mm<sup>2</sup>.
- (f) If the winding area of the core and bobbin is not enough, reselect the core style, go to (a) and redesign the inductor until the ideal inductor is achieved.

### **Output capacitor Cout**

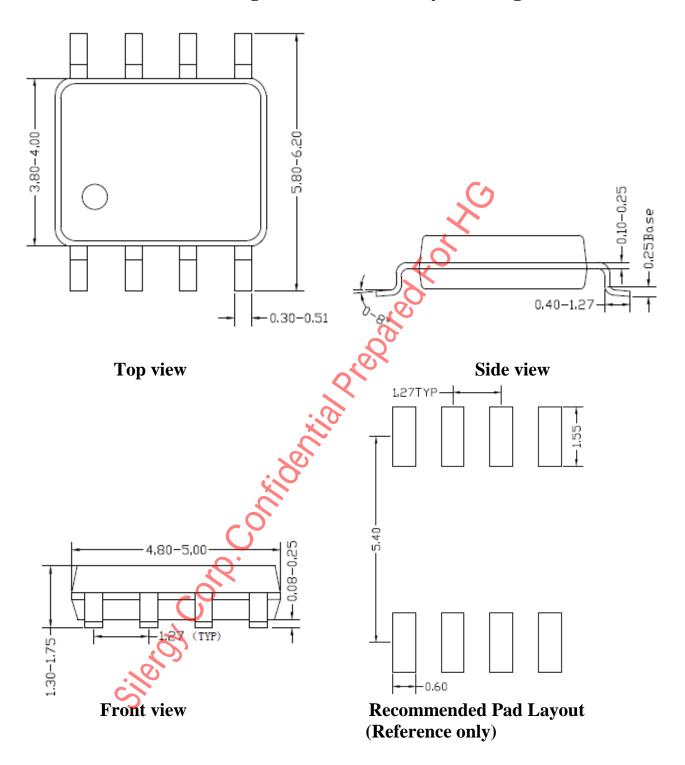
Choose proper output capacitance to satisfy current ripple. Output current ripple is set to  $\Delta I_0$ , then,

$$C_{\text{OUT}} = \frac{\sqrt{\left(\frac{2I_{\text{OUT}}}{\Delta I_{\text{O}}}\right)^{2} - 1}}{4\pi \times R_{\text{LED}} \times f_{\text{AC}}}$$

Where  $f_{AC}$  is the AC supply frequency;  $R_{LED}$  is the equivalent series resistor of LED load.



# SO8 Package outline & PCB layout design

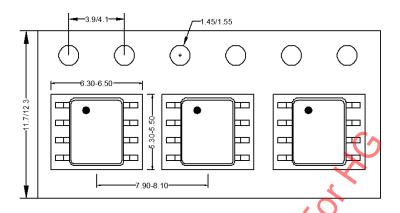


Notes: All dimension in millimeter and exclude mold flash & metal burr.



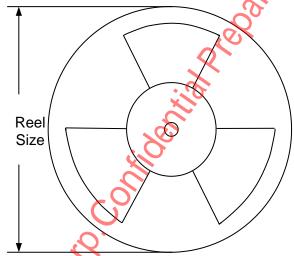
# **Taping & Reel Specification**

# 1. Taping orientation for packages (SO8)



Feeding direction →

# 2. Carrier Tape & Reel specification for packages



Package type	Tape width (mm)	Pocket pitch(mm)	Reel size (Inch)	Trailer length(mm)	Leader length (mm)	Qty per reel
SO8	12/0)	8	13"	400	400	2500



## **Revision History**

The revision history provided is for informational purpose only and is believed to be accurate, however, not warranted. Please make sure that you have the latest revision.

Date	Revision	Change
March 6, 2018	Revision 0.9	Initial Release

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